

450V N-Channel Power MOSFET



SOP-8

Pin Definition:

8 1. Source 1 8. Drain 1 2. Gate 1 7. Drain 1 3. Source 2 6. Drain 2 4. Gate 2 5. Drain 2

PRODUCT SUMMARY

V _{DS} (V)	$R_{DS(on)}(m\Omega)$	I _D (A)
450	4.25 @ V _{GS} =10V	0.5

General Description

The TSM1N45 is N-Channel enhancement mode power field effect transistors are produced using planar DMOS technology process. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand higher energy pulse in the avalanche and commutation mode. There devices are well suited for electronic ballasts base and half bridge configuration.

Features

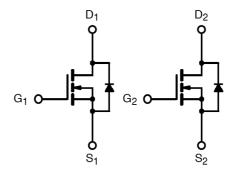
- Low gate charge @ typical 6.5nC
- Low Crss @ typical 6.5pF
- Avalanche energy specified
- Improved dv/dt capability
- Gate-Source Voltage ±50V guaranteed

Ordering Information

Part No.	Package	Packing
TSM1N45DCS RLG	SOP-8	2.5Kpcs / 13" Reel

Note: "G" denotes for Halogen Free

Block Diagram



Dual N-Channel MOSFET

Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	450	V
Gate-Source Voltage	V_{GS}	±50	V
Continuous Drain Current	I _D	0.5	Α
Pulsed Drain Current (Note 1)	I _{DM}	4	Α
Single Pulse Drain to Source Avalanche Energy (Note 2)	E _{AS}	108	mJ
Avalanche Current (Note 1)	I _{AR}	0.5	Α
Repetitive Avalanche Energy (Note 1)	E _{AR}	0.25	mJ
Peak Diode Recovery dv/dt (Note 3)	dv/dt	5.5	V/ns
Maximum Power Dissipation @Ta = 25°C	P _D	0.9	W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Thermal Performance

Parameter	Symbol	Limit	Unit
Thermal Resistance - Junction to Ambient	$R\Theta_{JA}$	80	°C/W

Notes: Surface mounted on FR4 board t ≤ 10sec



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Electrical Specifications (Ta=25°C, unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit	
Static	Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250uA$	BV _{DSS}	450			V	
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 0.25A$	R _{DS(ON)}		3.4	4.25	Ω	
Octo Therest all Divisions	$V_{DS} = V_{GS}, I_{D} = 250uA$	V _{GS(TH)}	2.3	3.0	3.7	V	
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \text{mA}$		3.1	4.2	4.9		
Zero Gate Voltage Drain Current	$V_{DS} = 450V, V_{GS} = 0V$	I _{DSS}			10	uA	
Gate Body Leakage	$V_{GS} = \pm 50V, V_{DS} = 0V$	I _{GSS}			±100	nA	
Forward Transconductance	$V_{DS} = 50V, I_{D} = 0.25A$	g fs		0.7		S	
Diode Forward Voltage	$I_S = 1A$, $V_{GS} = 0V$	V_{SD}			1.5	V	
Dynamic							
Total Gate Charge	$V_{DS} = 360V, I_{D} = 0.5A,$	Q_g		6.5		nC	
Gate-Source Charge	$V_{GS} = 10V$	Q_gs		0.9			
Gate-Drain Charge	(Note 4,5)	Q_gd		3.2			
Input Capacitance	\/	C _{iss}		185			
Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	C _{oss}		29		pF	
Reverse Transfer Capacitance	T = T.OIVITIZ	C_{rss}		6.5			
Switching							
Turn-On Delay Time	$V_{GS} = 25V, I_D = 0.5A,$ $V_{DS} = 225V, R_G = 25\Omega$	t _{d(on)}		7.5			
Turn-On Rise Time		t _r		21		nS	
Turn-Off Delay Time		t _{d(off)}		23		113	
Turn-Off Fall Time	(Note 4,5)	t _f		36			
Drain-Source Diode Characteristics and Maximum Ratings							
Maximum Continuous Drain-Source Diode Forward Current		Is			0.5	Α	
Maximum Pulsed Drain-Source Diode Forward Current		I _{SM}			4.0	Α	
Drain-Source Diode Forward Voltage	$V_{GS} = 25V, I_{S} = 0.5A$	V_{SD}			1.4	V	
Reverse Recovery Time	$V_{GS} = 25V, I_{S} = 0.5A.$ $dI_{F}/dt = 100A/\mu S$	t _{rr}		102		nS	
Reverse Recovery Charge	(Note 4)	Q _{rr}		0.26		μC	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=75mH, I_{AS} =1.6A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} =25°C 3. $I_{SD} \le 0.5A$, di/dt $\le 300A/\mu S$, $V_{DD} \le BV_{DSS}$, Starting T_{J} =25°C 4. Pulse test: pulse width $\le 300uS$, duty cycle $\le 2\%$ 5. Essentially independent of operating temperature

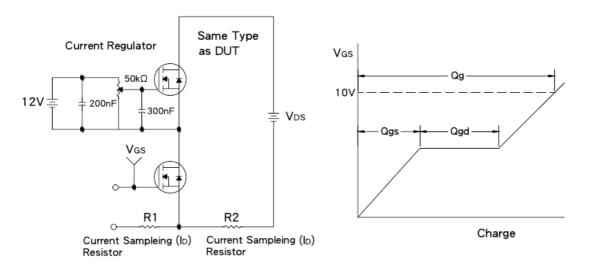
- 6. a) Reference point of the is the drain $R\Theta_{JL}$ lead
 - b) When mounted on 3"x4.5" FR-4 PCB without any pad copper in a still air environment $(R\Theta_{JA})$ is the sum of the junction-to-case and case-to-ambient thermal resistance. $R\Theta_{CA}$ is determined by the user's board design)



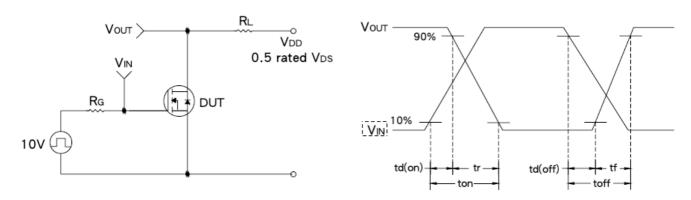
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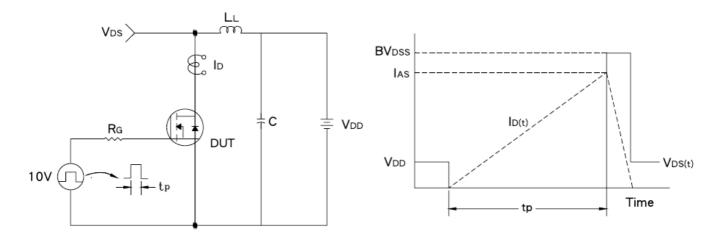
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



EAS Test Circuit & Waveform

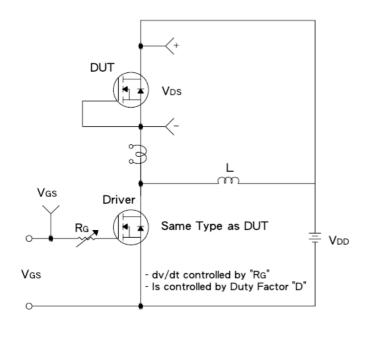


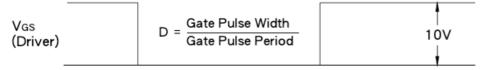


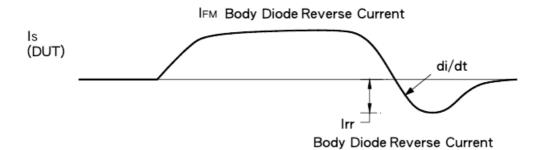
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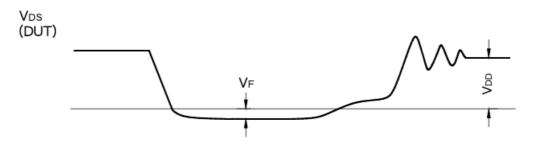


Diode Reverse Recovery Time Test Circuit & Waveform







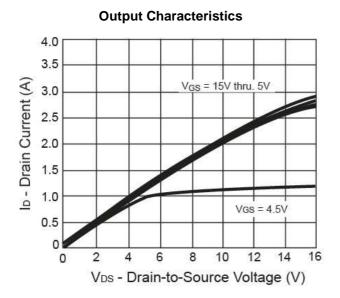




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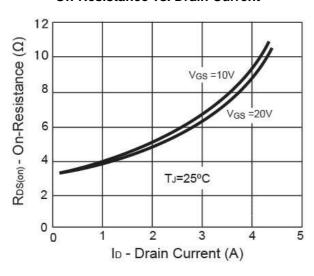


Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)

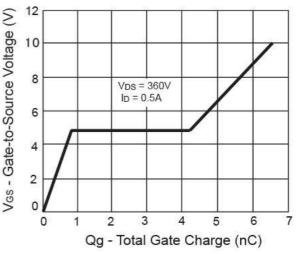


Transfer Characteristics 3.0 2.5 lo - Drain Current (A) 25°C 2.0 1.5 1.0 Note: 0.5 Vps=50V 380uS Pulse Test 0 0 2 6 10 12 Vgs - Gate-to-Source Voltage (V)

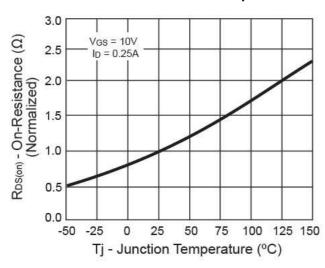




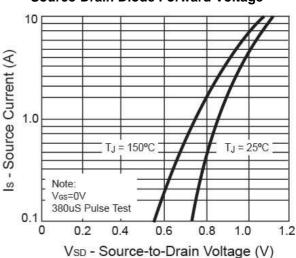




On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



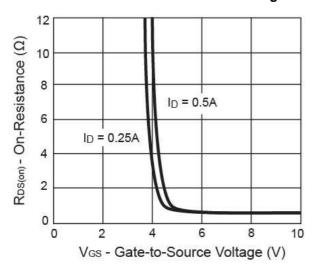


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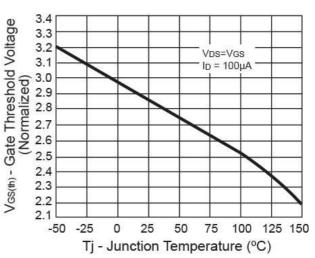


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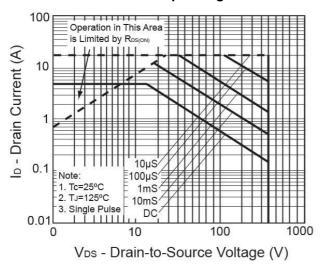
On-Resistance vs. Gate-Source Voltage



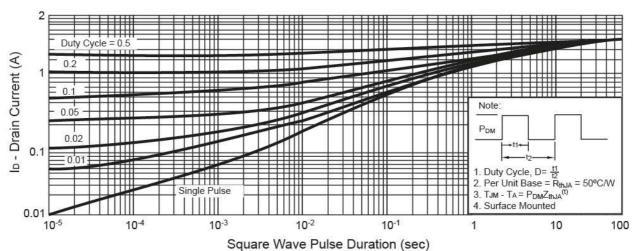
Threshold Voltage



Maximum Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

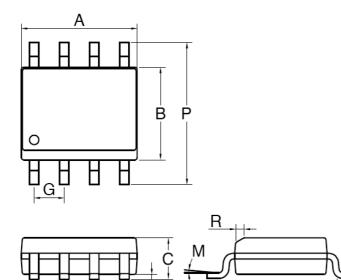






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SOP-8 Mechanical Drawing



SOP-8 DIMENSION					
DIM	MILLIMETERS		INCHES		
וווט	MIN	MAX	MIN	MAX.	
Α	4.80	5.00	0.189	0.196	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27BSC		0.05BSC		
K	0.10	0.25	0.004	0.009	
М	00	7°	00	7°	
Р	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

Version: A12

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